



SPC6332

N & P Pair Enhancement Mode MOSFET

DESCRIPTION

The SPC6332 is the N- and P-Channel enhancement mode power field effect transistors are produced using high cell density , DMOS trench technology. This high density process is especially tailored to minimize on-state resistance and provide superior switching performance. These devices are particularly suited for low voltage applications such as notebook computer power management and other battery powered circuits where high-side switching , low in-line power loss, and resistance to transients are needed.

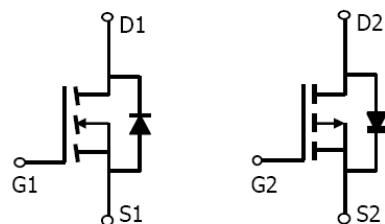
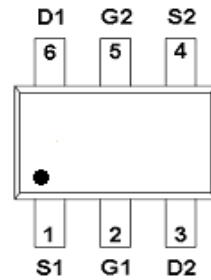
FEATURES

- N-Channel
 - 20V/0.95A,RDS(ON)=380mΩ@VGS=4.5V
 - 20V/0.75A,RDS(ON)=450mΩ@VGS=2.5V
 - 20V/0.65A,RDS(ON)=800mΩ@VGS=1.8V
- P-Channel
 - 20V/1.0A,RDS(ON)=520mΩ@VGS=-4.5V
 - 20V/0.8A,RDS(ON)=700mΩ@VGS=-2.5V
 - 20V/0.7A,RDS(ON)=950mΩ@VGS=-1.8V
- Super high density cell design for extremely low RDS (ON)
- Exceptional on-resistance and maximum DC current capability
- SOT-363 (SC-70-6L) package design

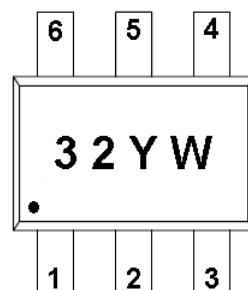
APPLICATIONS

- Power Management in Note book
- Portable Equipment
- Battery Powered System
- DC/DC Converter
- Load Switch
- DSC
- LCD Display inverter

PIN CONFIGURATION(SOT-363 / SC-70-6L)



PART MARKING



Y : Year Code
W : Week Code



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PIN DESCRIPTION

Pin	Symbol	Description
1	S1	Source 1
2	G1	Gate 1
3	D2	Drain 2
4	S2	Source 2
5	G2	Gate 2
6	D1	Drain1

ORDERING INFORMATION

Part Number	Package	Part Marking
SPC6332S36RGB	SOT-363	32

※ Week Code : A ~ Z(1 ~ 26) ; a ~ z(27 ~ 52)

※ SPC6332S36RGB : Tape Reel ; Pb – Free ; Halogen -Free

ABSOULTE MAXIMUM RATINGS

(TA=25°C Unless otherwise noted)

Parameter	Symbol	Typical		Unit
		N-Channel	P-Channel	
Drain-Source Voltage	V _{DSS}	20	-20	V
Gate –Source Voltage	V _{GSS}	±12	±12	V
Continuous Drain Current(T _J =150°C)	T _A =25°C	ID	1.2	A
	T _A =80°C		0.9	
Pulsed Drain Current	I _{DM}	4	-3	A
Continuous Source Current(Diode Conduction)	I _S	0.6	-0.6	A
Power Dissipation	T _A =25°C	P _D	0.3	W
	T _A =70°C		0.19	
Operating Junction Temperature	T _J	-55/150		°C
Storage Temperature Range	T _{STG}	-55/150		°C
Thermal Resistance-Junction to Ambient	T ≤ 10sec	R _{θJA}	360	°C/W
	Steady State		400	



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ELECTRICAL CHARACTERISTICS

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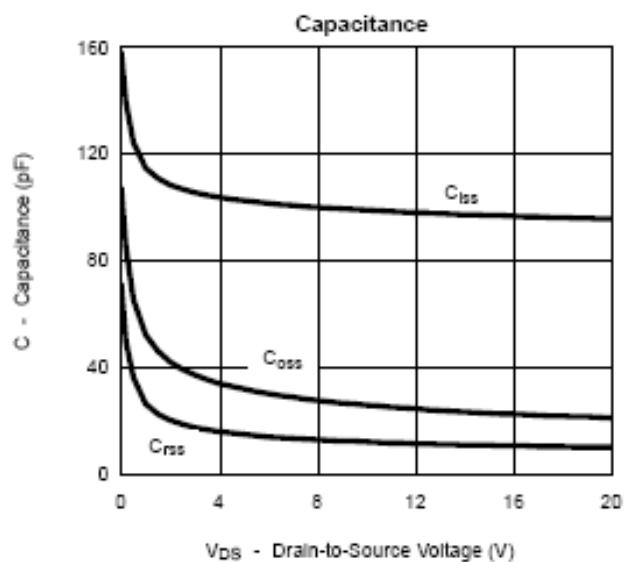
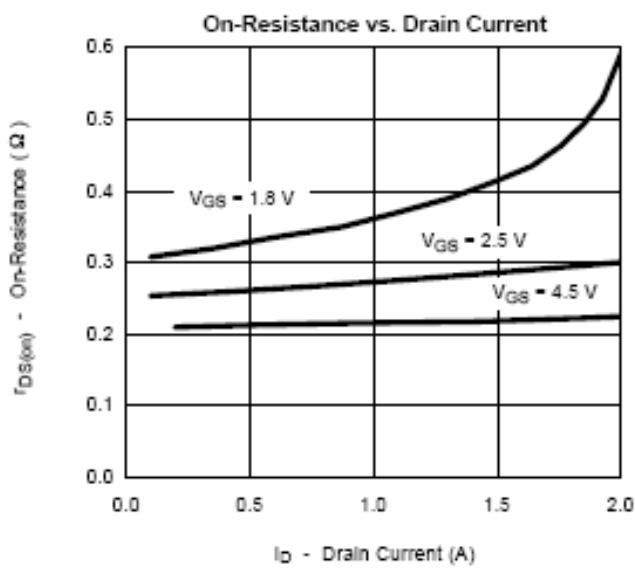
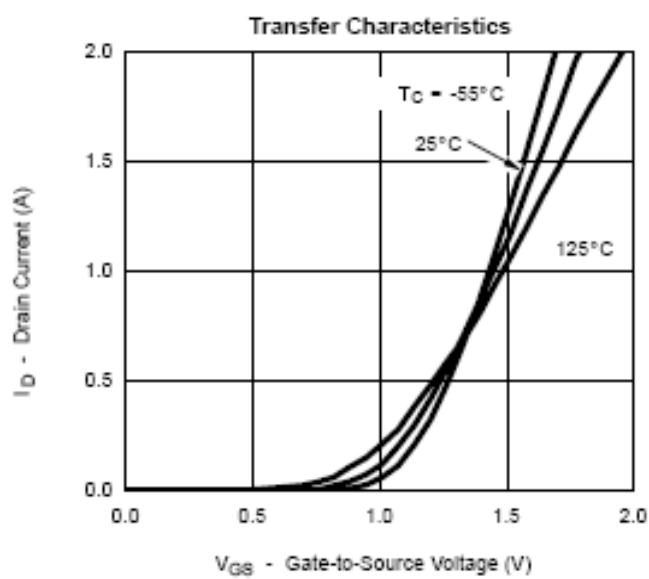
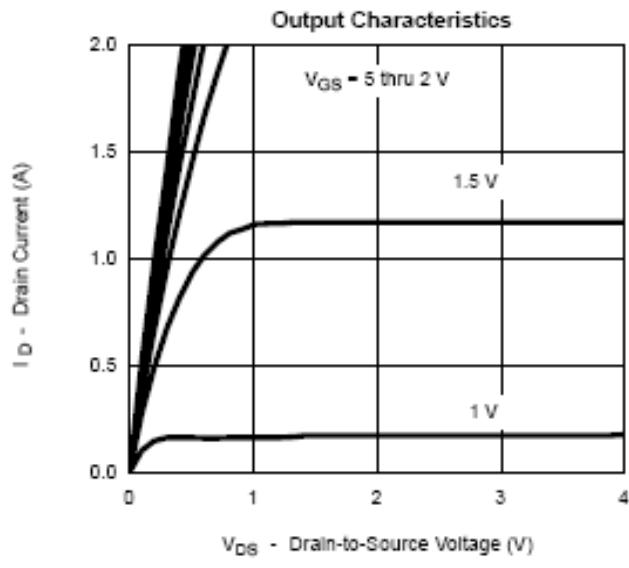
Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} =0V, ID= 250uA	N-Ch	20		
		V _{GS} =0V, ID=-250uA	P-Ch	-20		
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , ID=250uA	N-Ch	0.35		1.0
		V _{DS} =V _{GS} , ID=-250uA	P-Ch	-0.35		-0.8
Gate Leakage Current	I _{GSS}	V _{DS} =0V, V _{GS} =±12V	N-Ch		100	
		V _{DS} =0V, V _{GS} =±12V	P-Ch		-100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 20V, V _{GS} =0V	N-Ch		1	
		V _{DS} =-20V, V _{GS} =0V	P-Ch		-1	
		V _{DS} = 20V, V _{GS} =0V T _J =55°C	N-Ch		5	
		V _{DS} =-20V, V _{GS} =0V T _J =55°C	P-Ch		-5	
On-State Drain Current	I _{D(on)}	V _{DS} ≥ 4.5V, V _{GS} =5V	N-Ch	2		
		V _{DS} ≤ -4.5V, V _{GS} =-5V	P-Ch	-2		
Drain-Source On-Resistance	R _{D(on)}	V _{GS} =4.5V, ID=0.95A	N-Ch		0.26	0.38
		V _{GS} =-4.5V, ID=-1.0A	P-Ch		0.42	0.52
		V _{GS} =2.5V, ID=0.75A	N-Ch		0.32	0.45
		V _{GS} =-2.5V, ID=-0.8A	P-Ch		0.58	0.70
		V _{GS} =1.8V, ID=0.65A	N-Ch		0.42	0.80
		V _{GS} =-1.8V, ID=-0.5A	P-Ch		0.75	0.95
Forward Transconductance	g _{fs}	V _{DS} =10V, ID=1.2A	N-Ch		2.6	
		V _{DS} =-10V, ID=-1.0A	P-Ch		1.5	
Diode Forward Voltage	V _{SD}	I _S =0.5A, V _{GS} =0V	N-Ch		0.8	1.2
		I _S =-0.5A, V _{GS} =0V	P-Ch		-0.8	-1.2
Dynamic						
Total Gate Charge	Q _g	N-Channel V _{DS} =10V, V _{GS} =4.5V, ID=1.2A P-Channel V _{DS} =-10V, V _{GS} =-4.5V, ID=-1.0A	N-Ch		1.2	2.0
Gate-Source Charge	Q _{gs}		P-Ch		1.1	1.8
Gate-Drain Charge	Q _{gd}		N-Ch		0.2	
Turn-On Time	t _{d(on)}		P-Ch		0.3	
	t _r		N-Ch		0.3	
Turn-Off Time	t _{d(off)}	N-Channel V _{DD} =10V, R _L =20Ω, ID=0.5A V _{GEN} =4.5V, R _G =6Ω P-Channel V _{DD} =-10V, R _L =20Ω, ID=-0.5A V _{GEN} =-4.5V, R _G =6Ω	P-Ch		0.2	
	t _f		N-Ch		15	25
			P-Ch		18	30
			N-Ch		20	30
			P-Ch		25	40
			N-Ch		25	40
			P-Ch		20	30
			N-Ch		12	20
			P-Ch		12	20



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TYPICAL CHARACTERISTICS (N-Channel)

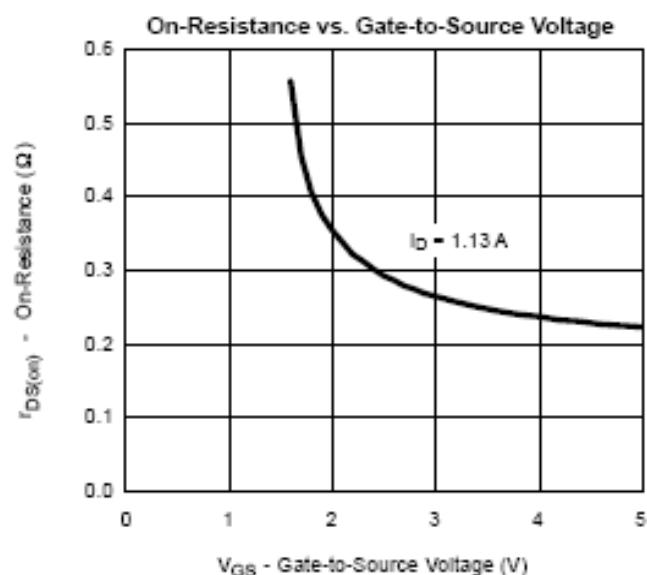
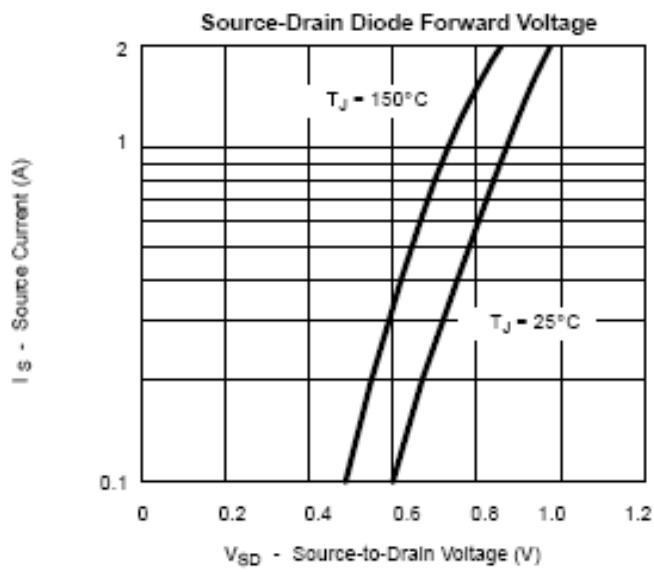
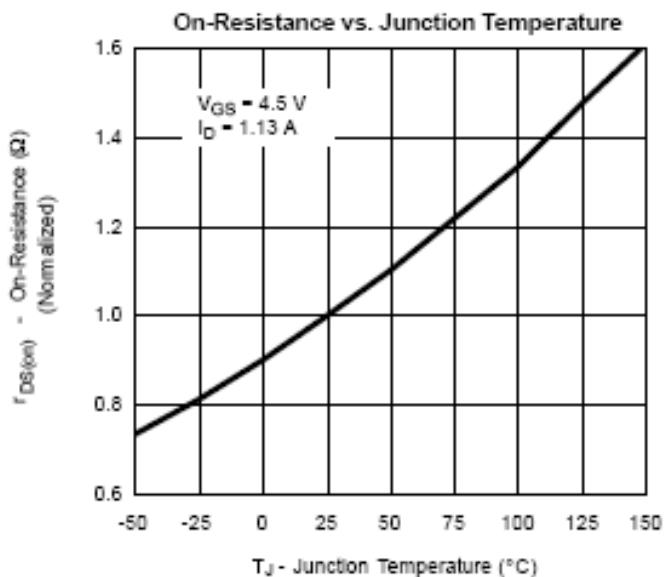
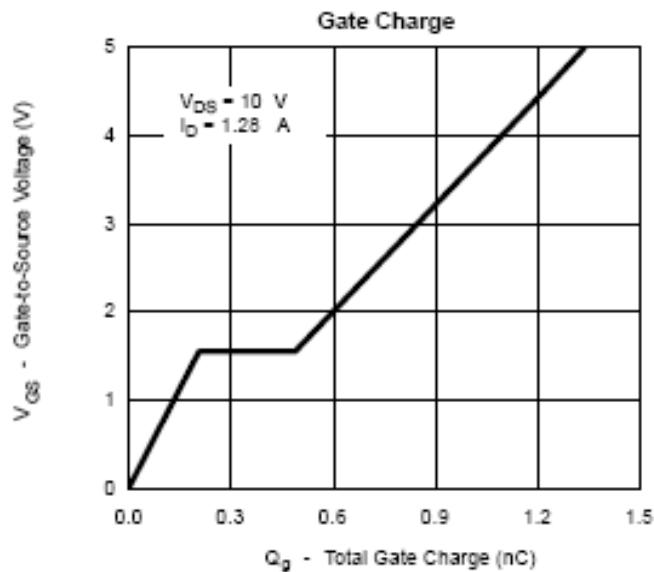




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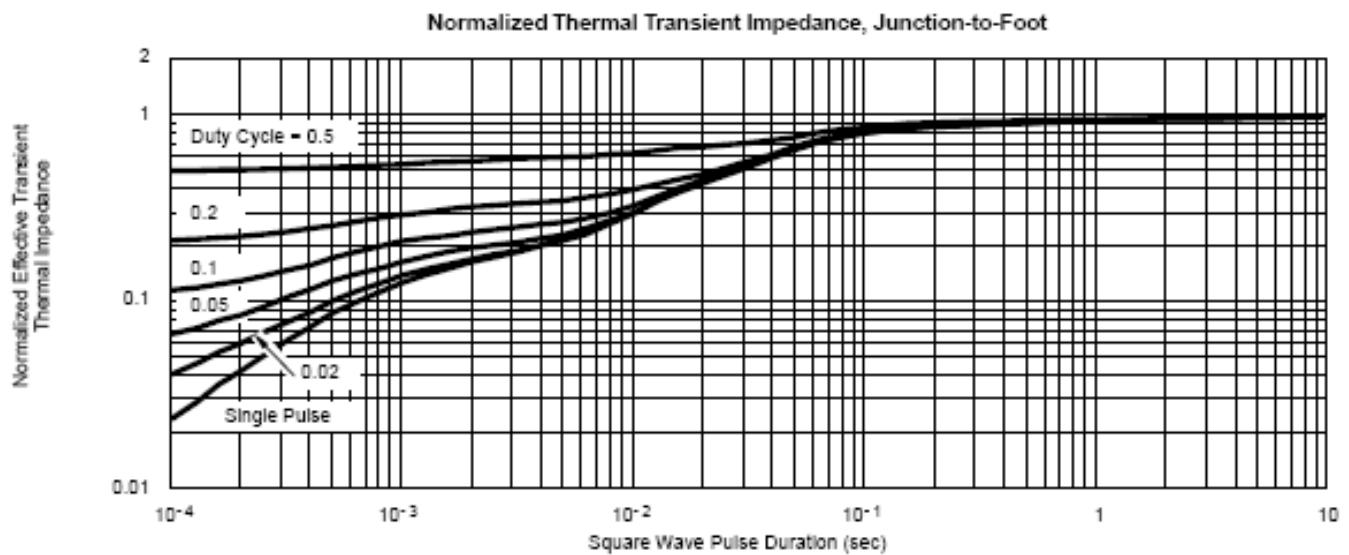
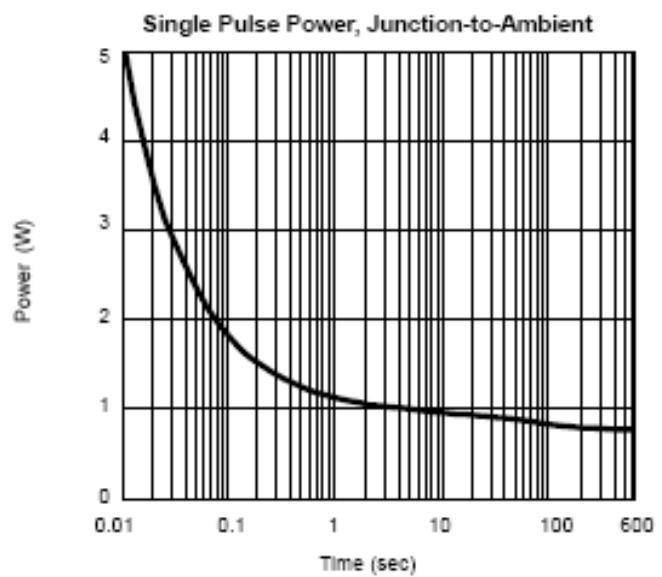
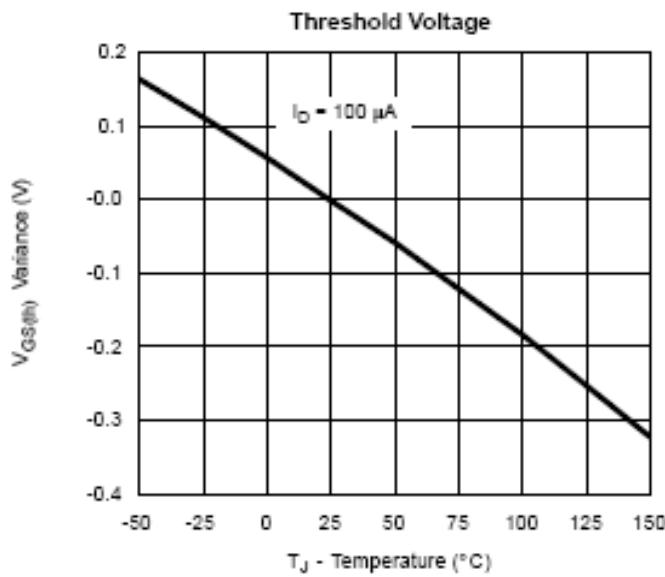




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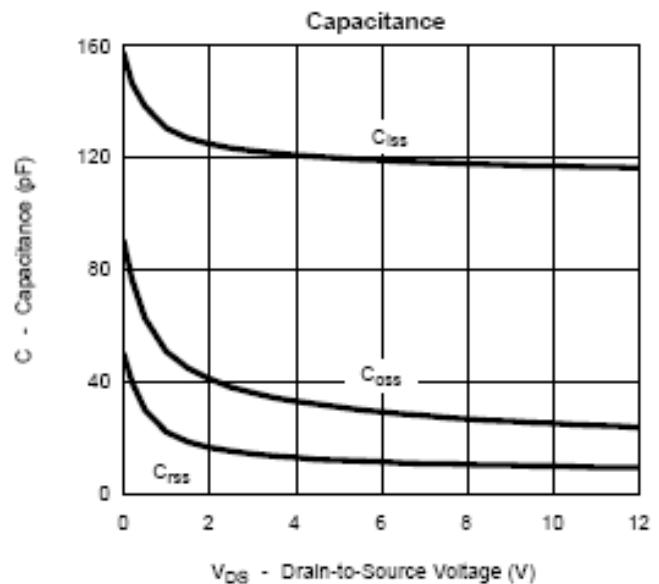
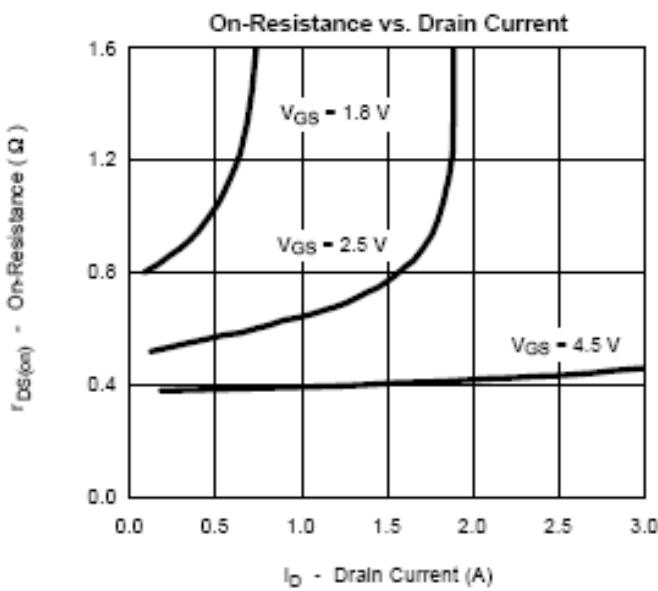
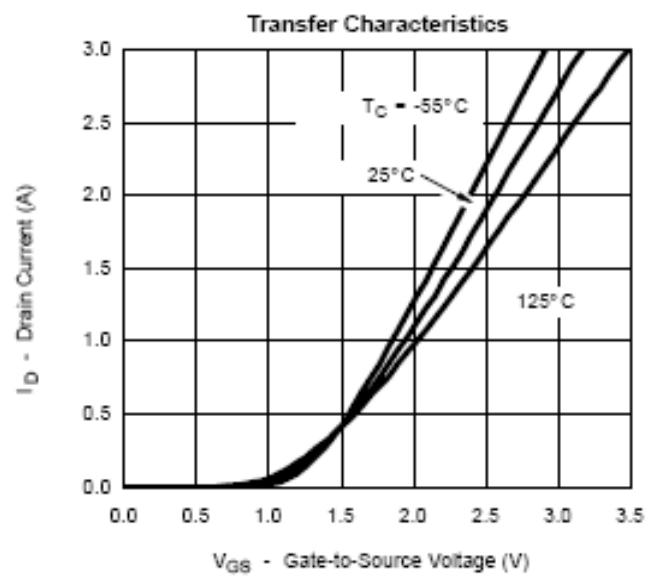
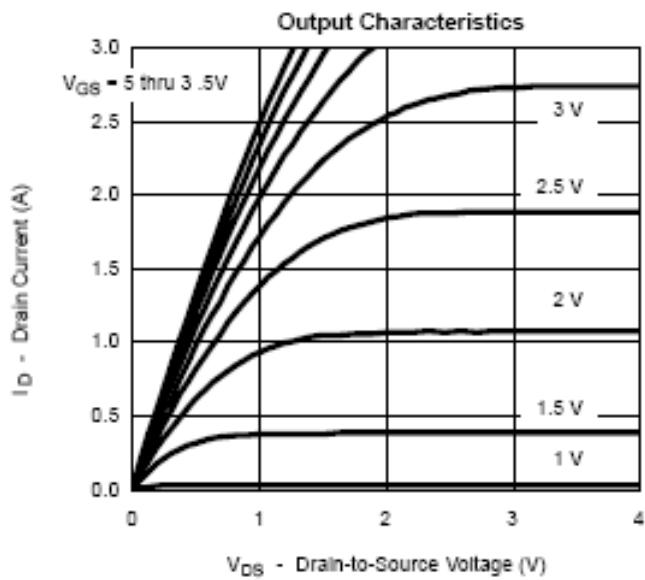




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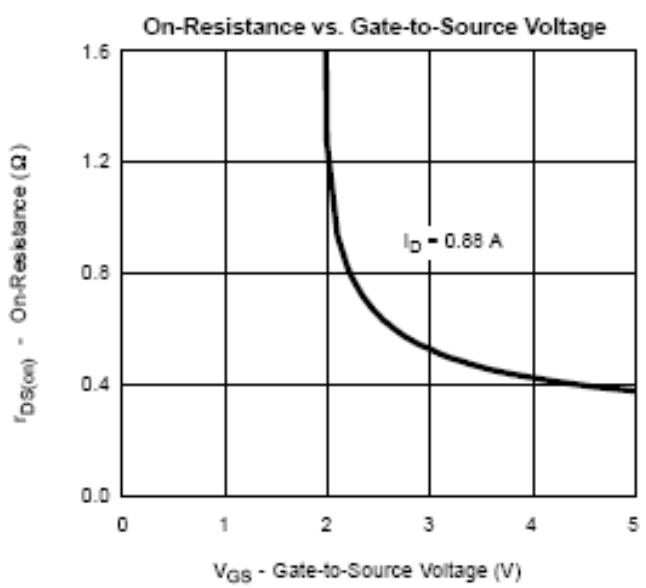
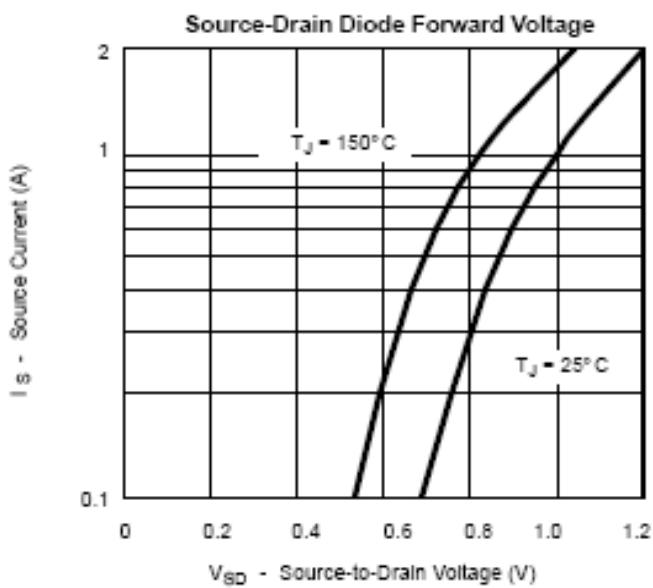
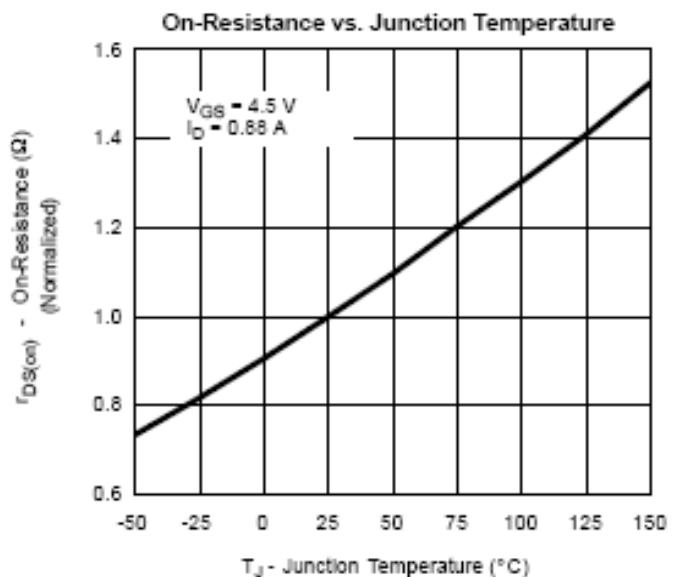
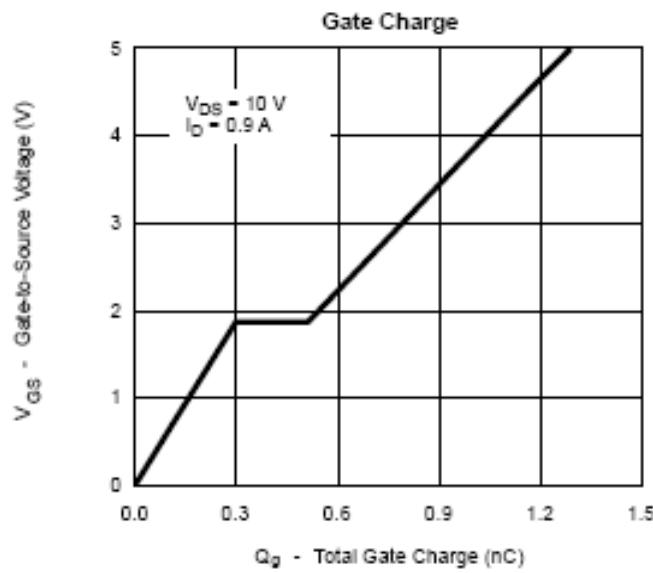




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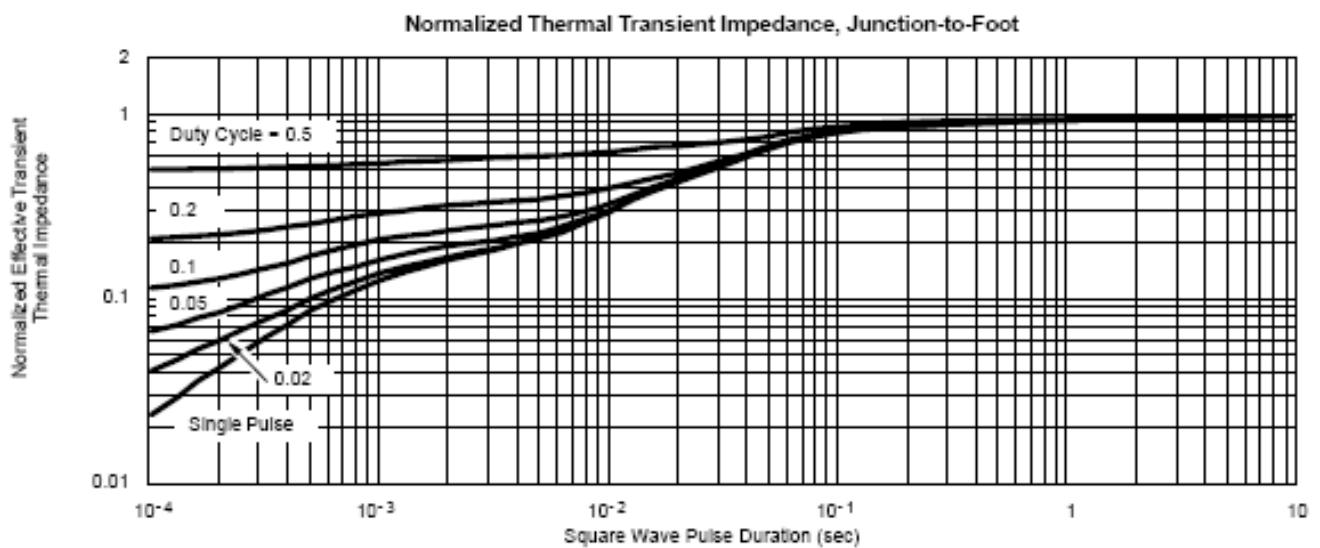
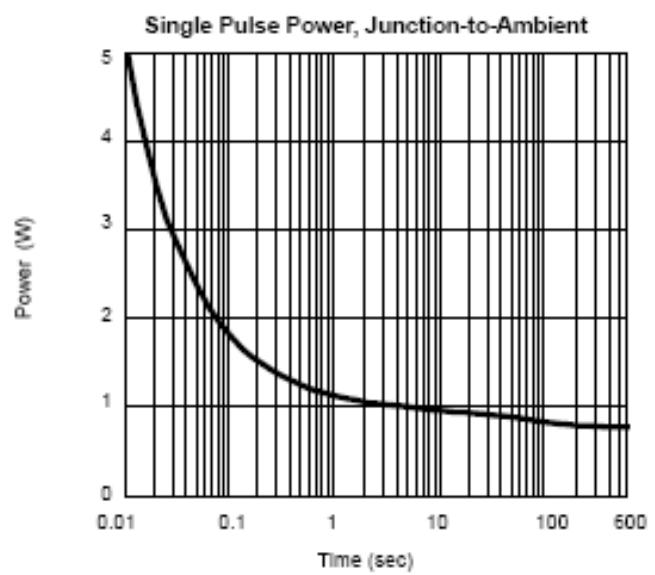
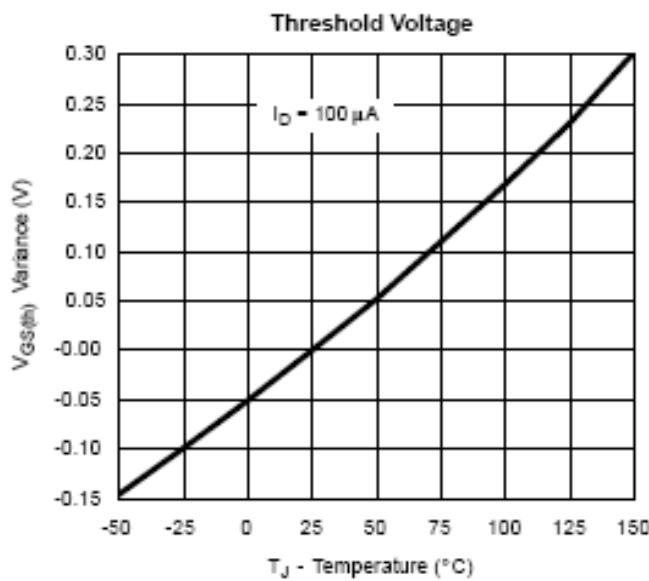




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